

| General Information |  |
| ---: | :--- |
| Supplier: | KEMET |
| Application: | Automotive (AEC-Q200 <br> Qualified) |
| Chip Size: | 0603 (1608 metric) |
| Temperature Coefficient: | C0G |
| Part Type Description: | SMD, MLCC, Ultra-Stable, Low <br> Loss, Auto Grade |
| Termination Type: | Tin (Sn) |
| Marked: | No |
| RoHS: | Yes |
| Approvals: | AEC-Q200 |
|  |  |


| Dimensions (mm) |  |  |
| :---: | :---: | :---: |
| Symbol | Dimension | Tolerance |
| L | 1.6 | $+/-0.15$ |
| W | 0.8 | $+/-0.15$ |
| T | 0.8 | $+/-0.07$ |
| B | 0.35 | $+/-0.15$ |
| S | 0.7 | MIN |


| Specifications |  |
| ---: | :--- |
| Capacitance: | 1000 pF |
| Voltage: | 250 V |
| Tolerance: | $+/-5 \%$ |
| Temperature Range: | $-55 /+125 \mathrm{C}$ |
| Dissipation Factor: | $0.1 \%$ |
| Failure Rate: | $\mathrm{N} / \mathrm{A}$ |
| Aging Rate: | $0 \%$ loss/decade hour |
| Insulation Resistance: | 100 GOhm |
| Dielectric Strength: | 625 V |


| Packaging Specifications |  |
| ---: | :--- |
| Package Kind: | T\&R |
| Package Size: | $7 \mathrm{in} / 180 \mathrm{~mm}$ |
| Package Type: | Paper Tape |
| Package Quantity: | 4000 |

